N-channel 600 V , $60 \mathrm{~m} \Omega$ typ., 42 A MDmesh M2 Power MOSFET in a TO-247 long leads package

## Features



TO-247 long leads


| Order code | V $_{\text {DS }} @$ TJmax. | R $_{\text {DS(on) }}$ max. | $\mathrm{I}_{\mathrm{D}}$ |
| :---: | :---: | :---: | :---: |
| STWA48N60M2 | 650 V | $70 \mathrm{~m} \Omega$ | 42 A |

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- $100 \%$ avalanche tested
- Zener-protected


## Applications

- Switching applications


## Description

This device is an N-channel Power MOSFET developed using MDmesh M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

## Product status

STWA48N60M2

| Device summary |  |
| :---: | :---: |
| Order code | STWA48N60M2 |
| Marking | 48N60M2 |
| Package | TO-247 long leads |
| Packing | Tube |

## Table 1. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{GS}}$ | Gate-source voltage | $\pm 25$ | V |
| $\mathrm{I}_{\mathrm{D}}$ | Drain current (continuous) at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 42 | A |
| $\mathrm{I}_{\mathrm{D}}$ | Drain current (continuous) at $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | 26 | A |
| $\mathrm{I}_{\mathrm{DM}}{ }^{(1)}$ | Drain current (pulsed) | 168 | A |
| $\mathrm{P}_{\text {TOT }}$ | Total power dissipation at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 300 | W |
| $\mathrm{dv} / \mathrm{dt}^{(2)}$ | Peak diode recovery voltage slope | 15 | $\mathrm{~V} / \mathrm{ns}$ |
| $\mathrm{dv} / \mathrm{dt}^{(3)}$ | MOSFET dv/dt ruggedness | 50 | $\mathrm{~V} / \mathrm{ns}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range | -55 to 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{j}}$ | Operating junction temperature range |  |  |

1. Pulse width limited by safe operating area.
2. $I_{S D} \leq 42 \mathrm{~A}, d i / d t \leq 400 \mathrm{~A} / \mu \mathrm{s} ; V_{D S(\text { peak })}<V_{(B R) D S S}, V_{D D}=400 \mathrm{~V}$
3. $V_{D S} \leq 480 \mathrm{~V}$

Table 2. Thermal data

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $R_{\text {thj-case }}$ | Thermal resistance junction-case | 0.42 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\mathrm{thj} \text {-amb }}$ | Thermal resistance junction-ambient | 50 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Table 3. Avalanche characteristics

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $I_{A R}$ | Avalanche current, repetitive or not repetitive <br> (pulse width limited by $T_{j m a x .) ~}$ | 7 | A |
| $\mathrm{E}_{\mathrm{AS}}$ | Single pulse avalanche energy <br> (starting $\left.\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}, \mathrm{I}_{\mathrm{D}}=\mathrm{I}_{\mathrm{AR}} ; \mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}\right)$ | 1 | J |

## 2

 Electrical characteristics( $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise specified)

Table 4. On /off-states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{(\mathrm{BR}) \mathrm{DSS}}$ | $\begin{array}{l}\text { Drain-source } \\ \text { breakdown voltage }\end{array}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}$ | 600 |  |  | V |
| $\mathrm{I}_{\mathrm{DSS}}$ | $\begin{array}{l}\text { Zero-gate voltage } \\ \text { drain current }\end{array}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=600 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=600 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=125^{\circ} \mathrm{C}^{(1)}$ |  |  |  |$)$

1. Defined by design, not subject to production test.

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {iss }}$ | Input capacitance | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=100 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | - | 3060 | - | pF |
| Coss | Output capacitance |  | - | 143 | - | pF |
| $\mathrm{Cr}_{\text {rss }}$ | Reverse transfer capacitance |  | - | 4.3 | - | pF |
| C oss eq. ${ }^{(1)}$ | Equivalent output capacitance | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0$ to 480 V | - | 630 | - | pF |
| $\mathrm{R}_{\mathrm{G}}$ | Intrinsic gate resistance | $\mathrm{f}=1 \mathrm{MHz}, \mathrm{I}_{\mathrm{D}}=0 \mathrm{~A}$ | - | 4.6 | - | $\Omega$ |
| $\mathrm{Q}_{\mathrm{g}}$ | Total gate charge | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=480 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=42 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GS}}=0 \text { to } 10 \mathrm{~V} \\ & \text { (see Figure 14. Test circuit for gate charge } \\ & \text { behavior ) } \end{aligned}$ | - | 70 | - | $n \mathrm{C}$ |
| $\mathrm{Q}_{\mathrm{gs}}$ | Gate-source charge |  | - | 10.5 | - | nC |
| $Q_{g d}$ | Gate-drain charge |  | - | 31 | - | nC |

1. $C_{\text {oss eq. }}$ is defined as a constant equivalent capacitance giving the same charging time as $C_{o s s}$ when $V_{D S}$ increases from 0 to $80 \% V_{D S S}$.

Table 6. Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | Turn-on delay time | $\mathrm{V}_{\mathrm{DD}}=300 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=21 \mathrm{~A}$, | - | 18.5 | - | ns |
| $\mathrm{t}_{\mathrm{r}}$ | Rise time | $\mathrm{R}_{\mathrm{G}}=4.7 \Omega, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}$ | - | 17 | - | ns |
| $\mathrm{t}_{\mathrm{d}(\mathrm{off})}$ | Turn-off delay time | (see Figure 13. Test circuit for resistive load <br> switching times and Figure 18. Switching time <br> waveform) | - | 119 | - | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall time |  | - | 13 | - | ns |

Table 7. Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ISD | Source-drain current |  | - |  | 42 | A |
| $\mathrm{ISDM}^{(1)}$ | Source-drain current (pulsed) |  | - |  | 168 | A |
| $\mathrm{V}_{\mathrm{SD}}{ }^{(2)}$ | Forward on voltage | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\text {SD }}=21 \mathrm{~A}$ | - |  | 1.6 | V |
| $\mathrm{trr}_{\text {r }}$ | Reverse recovery time | $\mathrm{I}_{\mathrm{SD}}=42 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ <br> $V_{D D}=60 \mathrm{~V}$ (see Figure 15. Test circuit for inductive load switching and diode recovery times) | - | 487 |  | ns |
| $\mathrm{Q}_{\mathrm{rr}}$ | Reverse recovery charge |  | - | 9.1 |  | $\mu \mathrm{C}$ |
| IRRM | Reverse recovery current |  | - | 37.5 |  | A |
| $\mathrm{trr}_{\text {r }}$ | Reverse recovery time | $\begin{aligned} & \mathrm{I}_{\mathrm{SD}}=42 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mathrm{s} \mathrm{~s} \\ & \mathrm{~V}_{\mathrm{DD}}=60 \mathrm{~V}, \mathrm{~T}_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ <br> (see Figure 15. Test circuit for inductive load switching and diode recovery times) | - | 605 |  | ns |
| $\mathrm{Q}_{\text {rr }}$ | Reverse recovery charge |  | - | 12.5 |  | $\mu \mathrm{C}$ |
| IRRM | Reverse recovery current |  | - | 41.5 |  | A |

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration $=300 \mu$ s, duty cycle $1.5 \%$.

### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area


Figure 2. Thermal impedance


Figure 3. Output characteristics


Figure 4. Transfer characteristics


Figure 5. Gate charge vs gate-source voltage


Figure 6. Static drain-source on-resistance


Figure 7. Capacitance variations


Figure 8. Output capacitance stored energy


Figure 9. Normalized gate threshold voltage vs temperature


Figure 10. Normalized on-resistance vs temperature


Figure 11. Normalized $\mathbf{V}_{(B R) \text { DSs }}$ vs temperature


Figure 12. Source-drain diode forward characteristics


## 3 Test circuits

Figure 13. Test circuit for resistive load switching times


Figure 15. Test circuit for inductive load switching and diode recovery times


Figure 14. Test circuit for gate charge behavior


Figure 16. Unclamped inductive load test circuit


Figure 17. Unclamped inductive waveform


Figure 18. Switching time waveform


## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

### 4.1 TO-247 long leads package information

Figure 19. TO-247 long leads package outline


Table 8. TO-247 long leads package mechanical data

| Dim. | mm |  |  |
| :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |
| A | 4.90 | 5.00 | 5.10 |
| A1 | 2.31 | 2.41 | 2.51 |
| A2 | 1.90 | 2.00 | 2.10 |
| b | 1.16 |  | 1.26 |
| b2 |  |  | 3.25 |
| b3 | 0.59 |  | 2.25 |
| c | 20.90 |  | 0.66 |
| D | 15.70 | 15.80 | 21.10 |
| E | 4.90 | 5.00 | 15.90 |
| E2 | 2.40 | 2.50 | 5.10 |
| E3 | 5.34 | 5.44 | 2.60 |
| e | 19.80 | 19.92 | 5.54 |
| L |  |  | 20.10 |
| L1 | 3.50 | 3.60 | 4.30 |
| P | 5.60 |  | 3.70 |
| Q | 6.05 | 6.15 | 6.00 |
| S |  |  | 6.25 |

## Revision history

Table 9. Document revision history

| Date | Revision | Changes |
| :---: | :---: | :--- |
| 01-Dec-2015 | 1 | First release. |
| 20-Jan-2017 | 2 | Updated Table 2: "Absolute maximum ratings", Table 4: "Avalanche <br> characteristics", Table 5: "On /off-states", Table 6: "Dynamic" and <br> Table 7: "Switching times". <br> Updated Section 2.2: "Electrical characteristics (curves)". |
| 19-Mar-2020 | 3 | Updated Table 6. Switching times. <br> Minor text changes. |

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